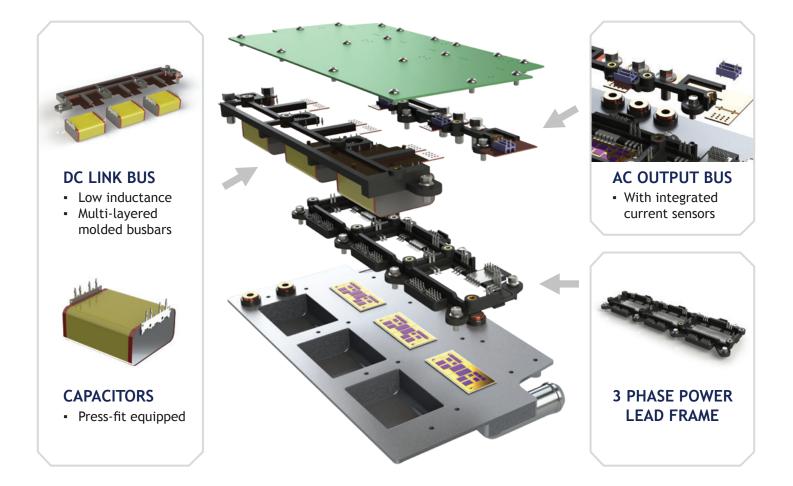
## Mechatronics Packaging & Interconnect Solutions



## **Solutions for Power Applications**

- Solderless, heat-free assembly
- Short, low resistance current paths
- Good thermal transfer
- Reliable & repeatable assembly
- Suitable for high & low voltage applications

## High-voltage Power Inverter with Integrated Pluggable Sub-assemblies



## Interplex